

Darlington Amplifier Transistors

- We declare that the material of product compliance with RoHS requirements.

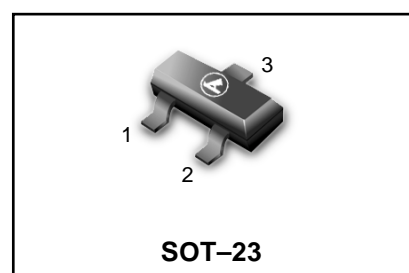
ORDERING INFORMATION

Device	Marking	Shipping
LMBTA13LT1G S-LMBTA13LT1G	1M	3000/Tape & Reel
LMBTA14LT1G S-LMBTA14LT1G	1N	3000/Tape & Reel
LMBTA13LT3G S-LMBTA13LT3G	1M	10000/Tape & Reel
LMBTA14LT3G S-LMBTA14LT3G	1N	10000/Tape & Reel

LMBTA13LT1G
LMBTA14LT1G
S-LMBTA13LT1G
S-LMBTA14LT1G

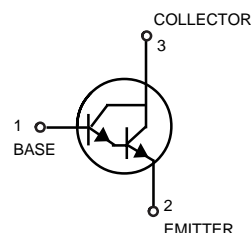
MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Collector–Emitter Voltage	V_{CES}	30	Vdc
Collector–Base Voltage	V_{CBO}	30	Vdc
Emitter–Base Voltage	V_{EBO}	10	Vdc
Collector Current — Continuous	I_C	300	mAdc



THERMAL CHARACTERISTICS

Characteristic	Symbol	Max	Unit
Total Device Dissipation FR– 5 Board, (1) $T_A = 25^\circ\text{C}$	P_D	225	mW
Derate above 25°C		1.8	mW/ $^\circ\text{C}$
Thermal Resistance, Junction to Ambient	$R_{\theta JA}$	556	$^\circ\text{C}/\text{W}$
Total Device Dissipation Alumina Substrate, (2) $T_A = 25^\circ\text{C}$	P_D	300	mW
Derate above 25°C		2.4	mW/ $^\circ\text{C}$
Thermal Resistance, Junction to Ambient	$R_{\theta JA}$	417	$^\circ\text{C}/\text{W}$
Junction and Storage Temperature	T_J, T_{stg}	-55 to +150	$^\circ\text{C}$



DEVICE MARKING

(S-)LMBTA13LT1G = 1M; (S-)LMBTA14LT1G = 1N;

ELECTRICAL CHARACTERISTICS ($T_A = 25^\circ\text{C}$ unless otherwise noted.)

Characteristic	Symbol	Min	Max	Unit
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OFF CHARACTERISTICS

Collector–Emitter Breakdown Voltage ($I_C = 100 \mu\text{Adc}, V_{BE} = 0$)	$V_{(BR)CEO}$	30	—	Vdc
Collector Cutoff Current ($V_{CB} = 30\text{Vdc}, I_E = 0$)	I_{CBO}	—	100	nAdc
Emitter Cutoff Current ($V_{EB} = 10\text{Vdc}, I_C = 0$)	I_{EBO}	—	100	nAdc

1. FR–5 = 1.0 x 0.75 x 0.062 in.

2. Alumina = 0.4 x 0.3 x 0.024 in. 99.5% alumina.

LMBTA13LT1G LMBTA14LT1G
S-LMBTA13LT1G S-LMBTA14LT1G

ELECTRICAL CHARACTERISTICS ($T_A = 25^\circ\text{C}$ unless otherwise noted) (Continued)

Characteristic	Symbol	Min	Max	Unit
ON CHARACTERISTICS (3)				
DC Current Gain ($I_C = 10 \text{ mAdc}, V_{CE} = 5.0 \text{ Vdc}$)	h_{FE}	5,000	—	—
	LMBTA13	5,000	—	—
	LMBTA14	10,000	—	—
($I_C = 100\text{mAdc}, V_{CE} = 5.0\text{Vdc}$)	LMBTA13	10,000	—	—
	LMBTA14	20,000	—	—
Collector–Emitter Saturation Voltage ($I_C = 100 \text{ mAdc}, I_B = 0.1 \text{ mAdc}$)	$V_{CE(sat)}$	—	1.5	Vdc
Base–Emitter On Voltage ($I_C = 100\text{mAdc}, V_{CE} = 5.0\text{Vdc}$)	V_{BE}	—	2.0	Vdc

SMALL–SIGNAL CHARACTERISTICS

Current – Gain–Bandwidth Product(4) ($V_{CE} = 5.0 \text{ Vdc}, I_C = 10\text{mAdc}, f = 100 \text{ MHz}$)	f_T	125	—	MHz
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3. Pulse Test: Pulse Width $\leq 300 \mu\text{s}$, Duty Cycle $\leq 2.0\%$.

4. $f_T = |h_{fe}| * f_{test}$.

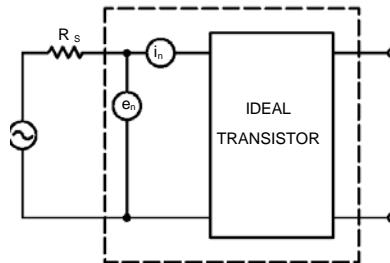


Figure 1. Transistor Noise Model

LMBTA13LT1G LMBTA14LT1G
S-LMBTA13LT1G S-LMBTA14LT1G

NOISE CHARACTERISTICS

($V_{CE} = 5.0 \text{ Vdc}$, $T_A = 25^\circ\text{C}$)

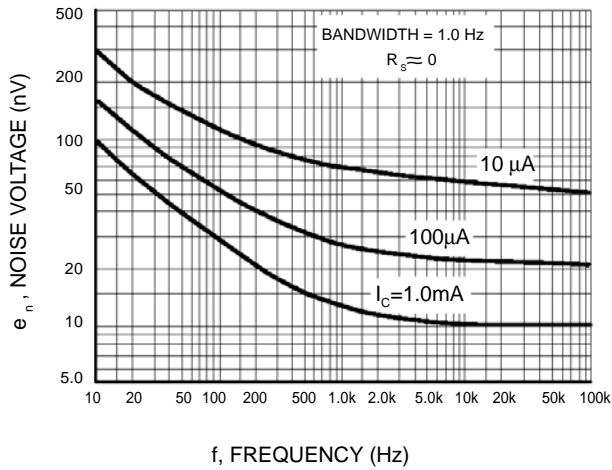


Figure 2. Noise Voltage

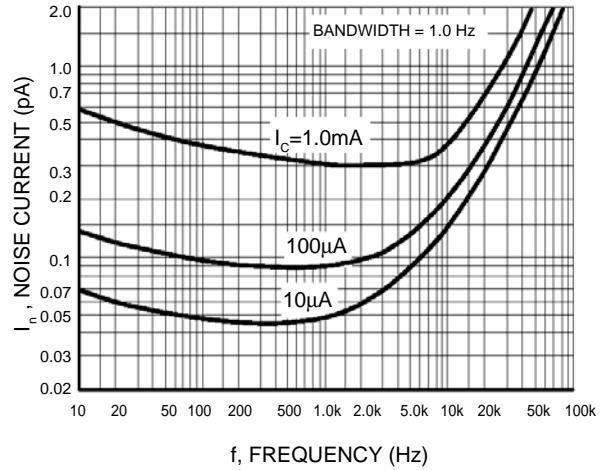


Figure 3. Noise Current

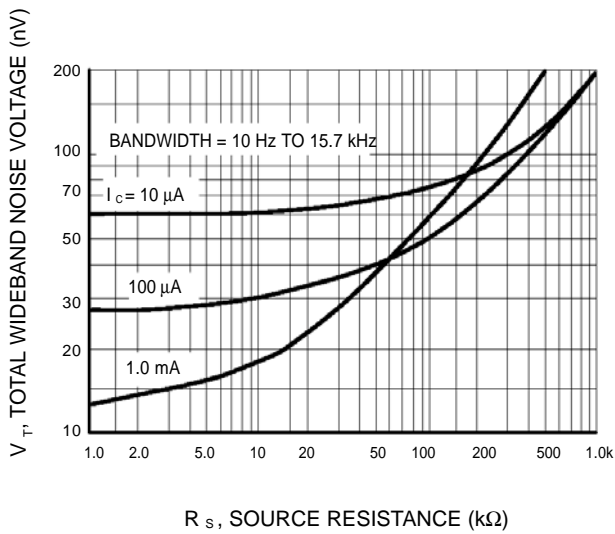


Figure 4. Total Wideband Noise Voltage

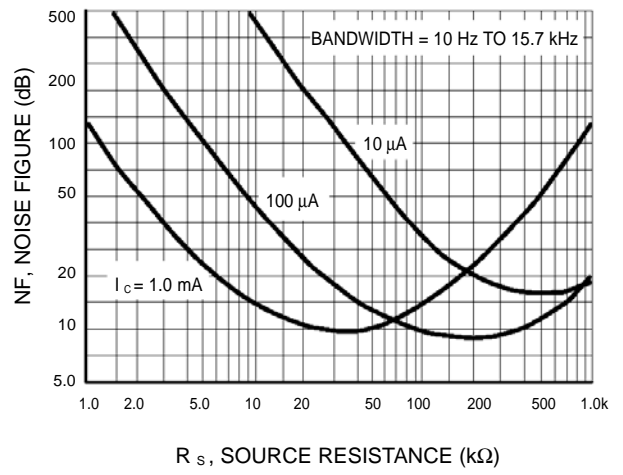


Figure 5. Wideband Noise Figure

LMBTA13LT1G LMBTA14LT1G
S-LMBTA13LT1G S-LMBTA14LT1G

SMALL-SIGNAL CHARACTERISTICS

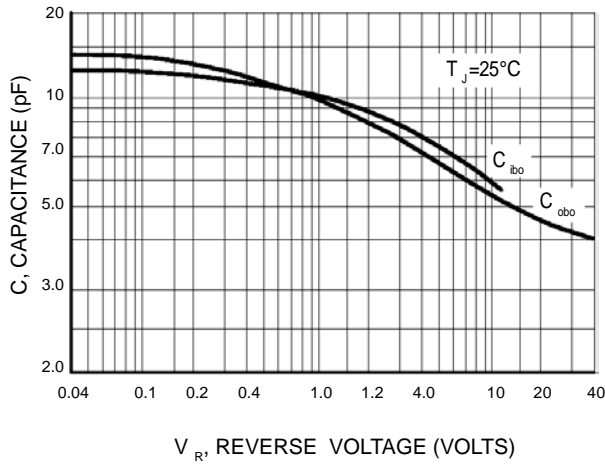


Figure 6. Capacitance

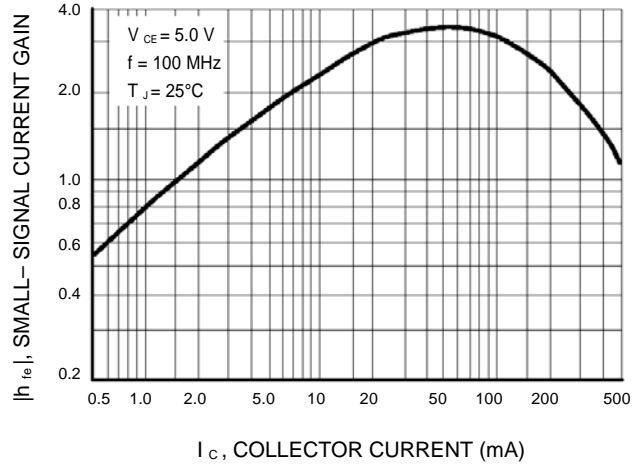


Figure 7. High Frequency Current Gain

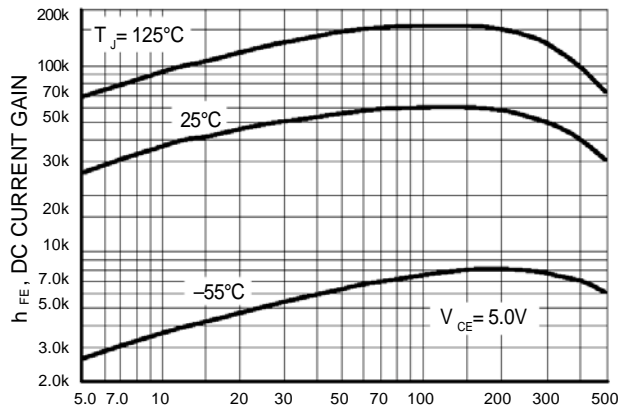


Figure 8. DC Current Gain

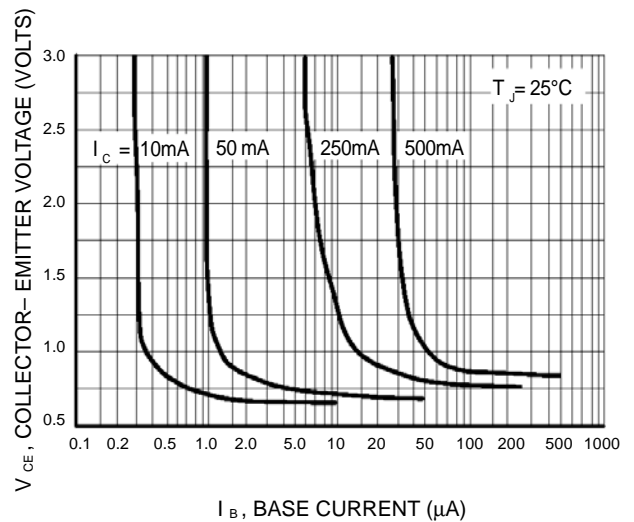


Figure 9. Collector Saturation Region

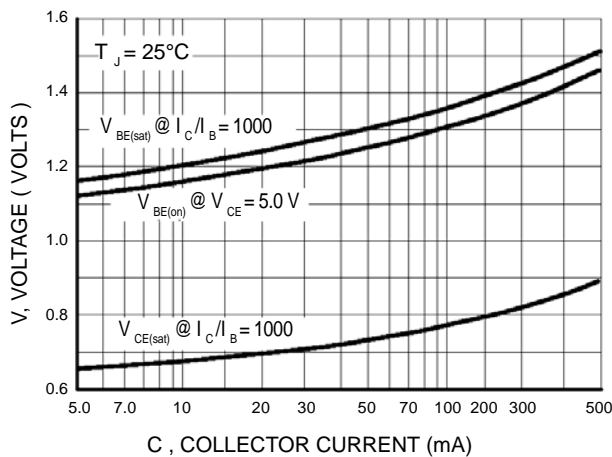


Figure 17. "ON" Voltages

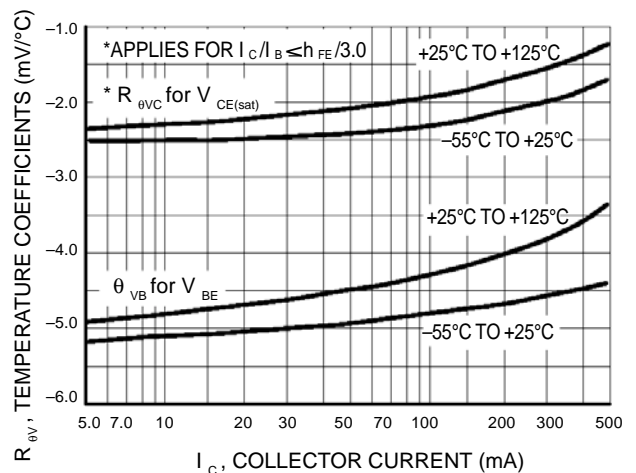


Figure 18. Temperature Coefficients

LMBTA13LT1G LMBTA14LT1G
S-LMBTA13LT1G S-LMBTA14LT1G

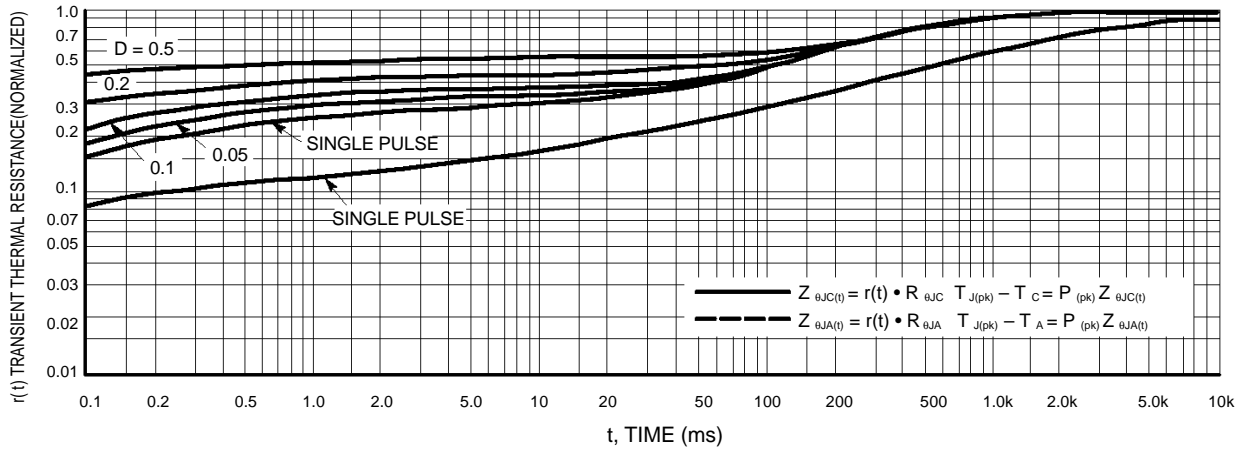


Figure 12. Thermal Response

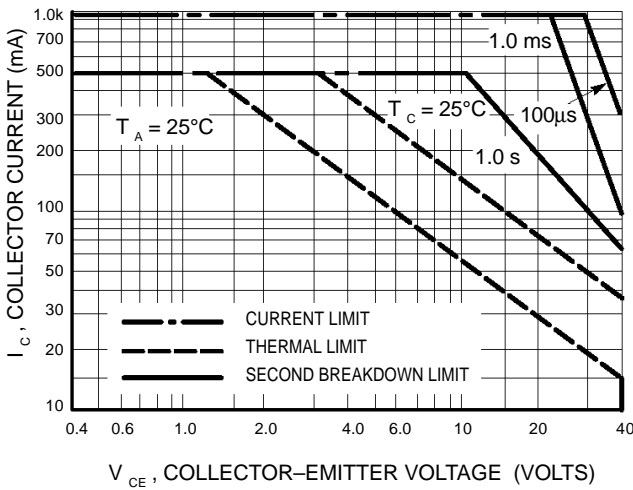
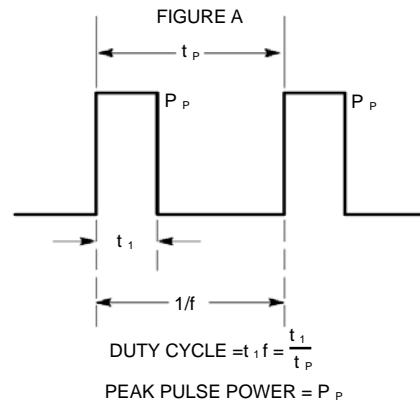


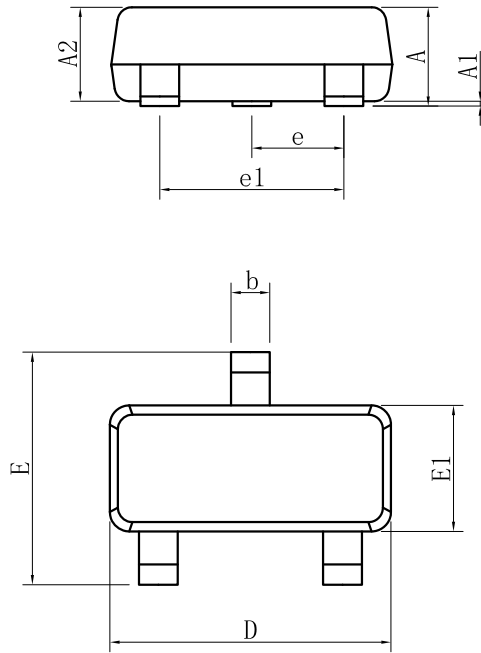
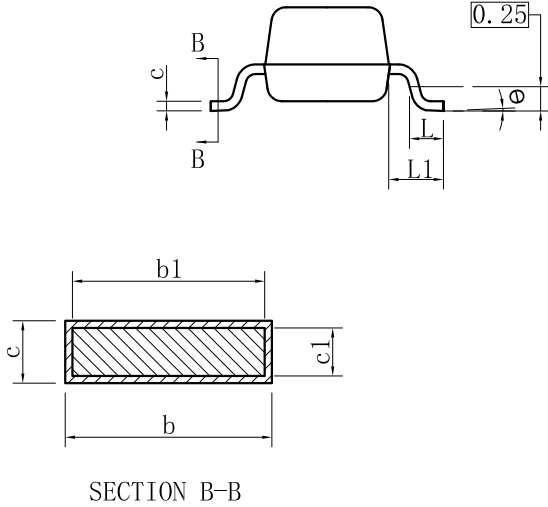
Figure 13. Active Region Safe Operating Area



Design Note: Use of Transient Thermal Resistance Data

LMBTA13LT1G LMBTA14LT1G
S-LMBTA13LT1G S-LMBTA14LT1G

OUTLINE AND DIMENSIONS

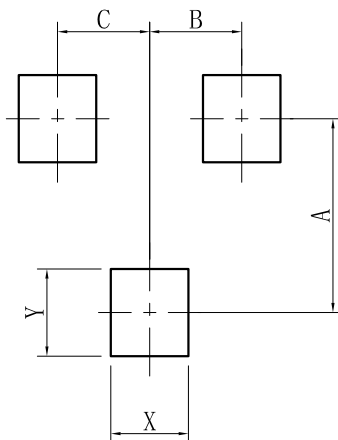


SOT23			
DIM	MIN	NOR	MAX
A	0.89	-	1.12
A1	0.01	-	0.10
A2	0.88	0.95	1.02
b	0.30	-	0.50
b1	0.30	0.40	0.45
c	0.08	-	0.20
c1	0.08	0.10	0.16
D	2.80	2.90	3.04
E	2.10	-	2.64
E1	1.20	1.30	1.40
e	0.95BSC		
e1	1.90BSC		
L	0.40	0.46	0.60
L1	0.54REF		
θ	0°	-	8°
All Dimensions in mm			

GENERAL NOTES

1. Top package surface finish Ra0.4±0.2um
2. Bottom package surface finish Ra0.7±0.2um
3. Side package surface finish Ra0.4±0.2um

SOLDERING FOOTPRINT



SOT-23	
DIM	(mm)
X	0.80
Y	0.90
A	2.00
B	0.95
C	0.95

DISCLAIMER

- Curve guarantee in the specification. The curve of test items with electric parameter is used as quality guarantee. The curve of test items without electric parameter is used as reference only.
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